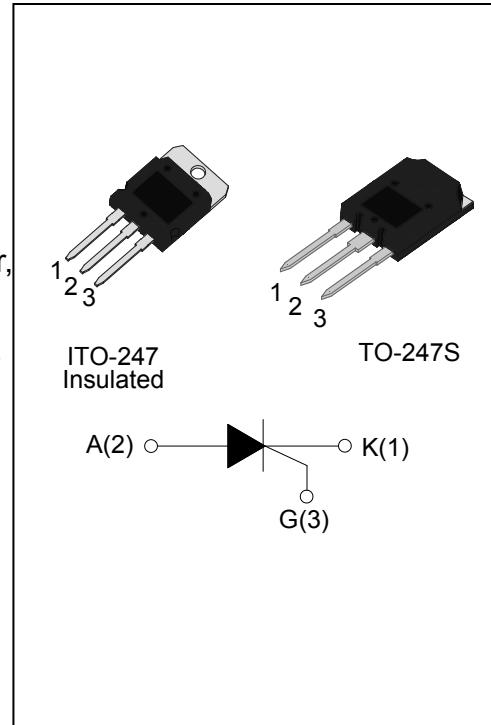


KJS12110

DESCRIPTION:

With high ability to withstand the shock loading of large current, KJS12110 series provides high dv/dt rate with high frequency noise immunity.

Products are especially recommended for use on solid state relay, motorcycle, power charger, T-tools etc. From all three pins to external heatsink, KJS12110 provides an insulation voltage of 2500 V_{RMS}.



MAIN FEATURES

Symbol	Value	Unit
I _{T(RMS)}	110	A
V _{DRM} / V _{RRM}	1200	V

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Storage junction temperature range	T _{stg}	-40-150	°C
Operating junction temperature range	T _j	-40-125	°C
Repetitive peak off-state voltage(T _j =25°C)	V _{DRM}	1200	V
Repetitive peak reverse voltage(T _j =25°C)	V _{RRM}	1200	V
Non repetitive surge peak Off-state voltage	V _{DSM}	V _{DRM} +100	V
Non repetitive peak reverse voltage	V _{RSM}	V _{RRM} +100	V
RMS on-state current (T _C =80°C)	I _{T(RMS)}	110	A
TO-247S(T _C =90°C)			
Non repetitive surge peak on-state current (tp=10ms)	I _{TSM}	1100	A
I ² t value for fusing (tp=10ms)	I ² t	5500	A ² s
Critical rate of rise of on-state current (I _G =2×I _{GT})	dI/dt	150	A/μs
Peak gate current	I _{GM}	8	A

KJS12110

Average gate power dissipation	$P_{G(AV)}$	2	W
Peak gate power	P_{GM}	10	W

ELECTRICAL CHARACTERISTICS($T_j=25^\circ C$ unless otherwise specified)

Symbol	Test Condition	Value			Unit
		MIN.	TYP.	MAX.	
I_{GT}	$V_D=12V R_L=33\Omega$	-	-	70	mA
V_{GT}		-	-	1.5	V
V_{GD}	$V_D=V_{DRM} T_j=125^\circ C R_L=3.3K\Omega$	0.25	-	-	V
I_L	$I_G=1.2I_{GT}$	-	-	150	mA
I_H	$I_T=1A$	-	-	120	mA
dV/dt	$V_D=2/3V_{DRM}$ Gate Open $T_j=125^\circ C$	1000	-	-	V/ μ s

STATIC CHARACTERISTICS

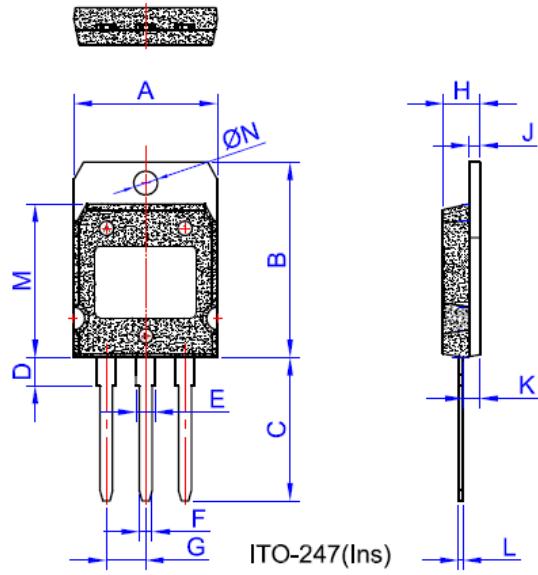
Symbol	Parameter		Value(MAX)	Unit
V_{TM}	$I_{TM}=150A$	$t_p=380\mu s$	$T_j=25^\circ C$	1.8 V
I_{DRM}	$V_D=V_{DRM}$	$T_j=25^\circ C$	10	μA
I_{RRM}		$T_j=125^\circ C$	12	mA

THERMAL RESISTANCES

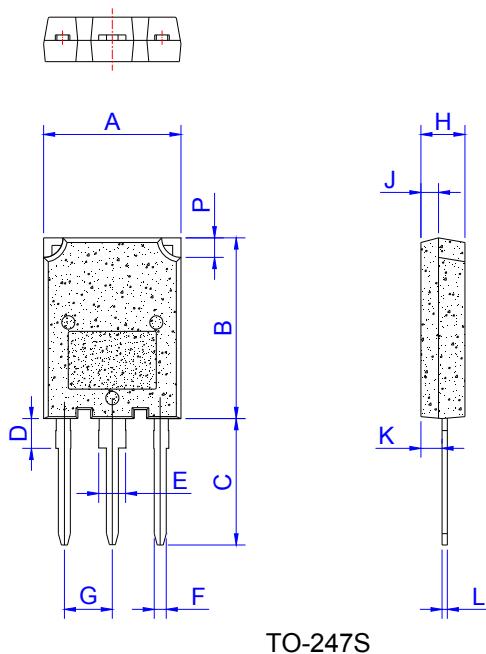
Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	junction to case(AC)	ITO-247(Ins)	0.41	$^\circ C/W$
		TO-247S	0.40	

KJS12110

PACKAGE MECHANICAL DATA



Ref	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	19.7	19.9	20.1	0.776	0.783	0.791
B	26.9	27.1	27.3	1.059	1.067	1.075
C	19.4	19.9	20.4	0.764	0.783	0.803
D	3.8	3.9	4.0	0.15	0.154	0.157
E	2.56	2.66	2.76	0.101	0.105	0.109
F	1.66	1.76	1.86	0.065	0.069	0.073
G		5.45			0.215	
H	5.05	5.10	5.5	0.199	0.201	0.217
J	1.45	1.50	1.55	0.057	0.059	0.061
K	2.20	2.30	2.40	0.087	0.091	0.094
L	0.60	0.70	0.80	0.024	0.028	0.031
M	21.2	21.3	21.4	0.835	0.839	0.843
ØN	3.20	3.30	3.40	0.126	0.130	0.134



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.1		16.1	0.594		0.634
B	19.8		20.8	0.78		0.819
C	13.8		14.8	0.543		0.583
D	3.00		4.00	0.118		0.157
E	2.75		3.35	0.108		0.132
F	1.30		1.50	0.051		0.059
G	5.10		5.80	0.201		0.228
H	4.50		5.50	0.177		0.217
J	1.45		2.15	0.057		0.085
K	1.90		2.80	0.075		0.110
L	0.55		0.80	0.022		0.031
P	2.00		2.40	0.079		0.094

FIG.1: Maximum power dissipation versus RMS on-state current

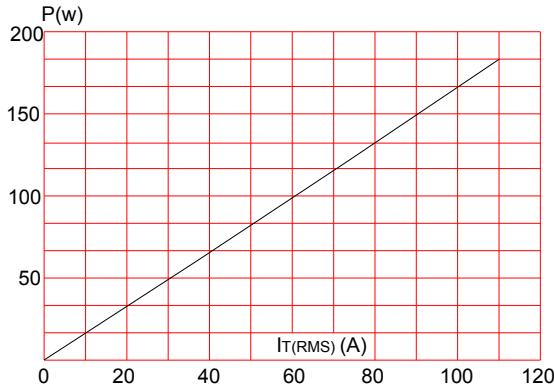


FIG.3: Surge peak on-state current versus number of cycles

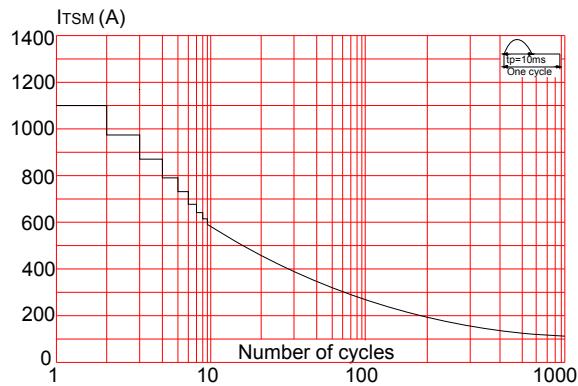


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10ms$, and corresponding value of I^2t

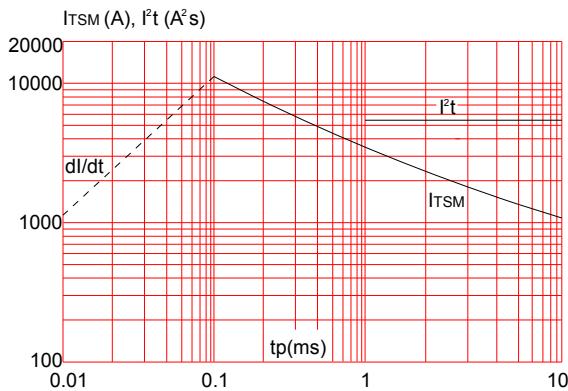


FIG.2: RMS on-state current versus case temperature

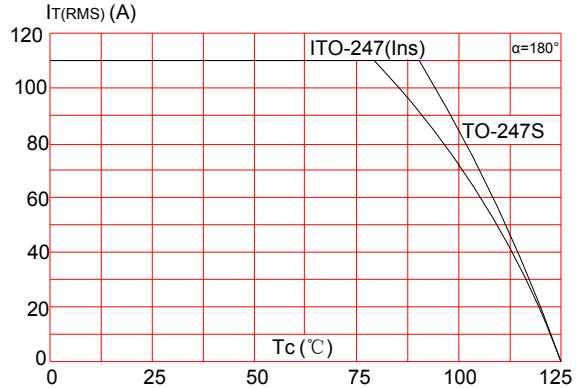


FIG.4: On-state characteristics (maximum values)

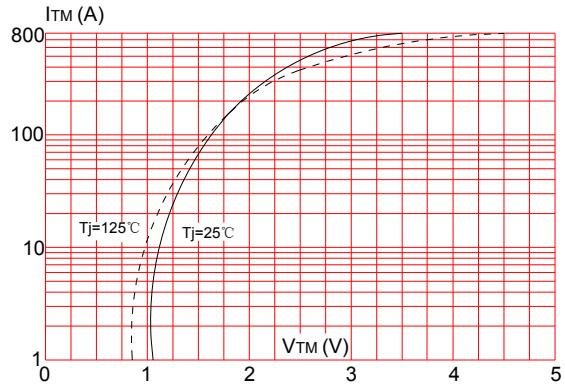


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature

